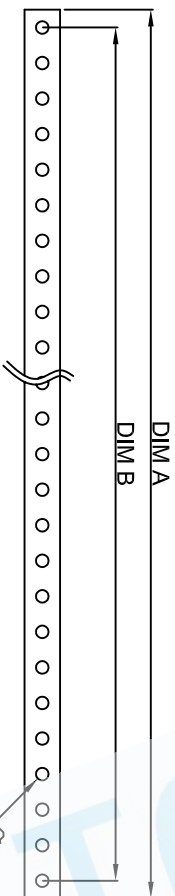
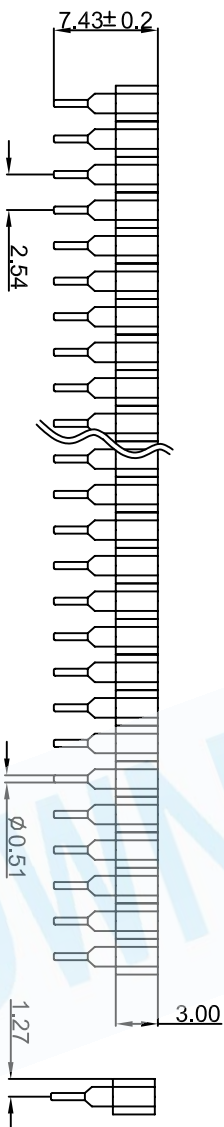
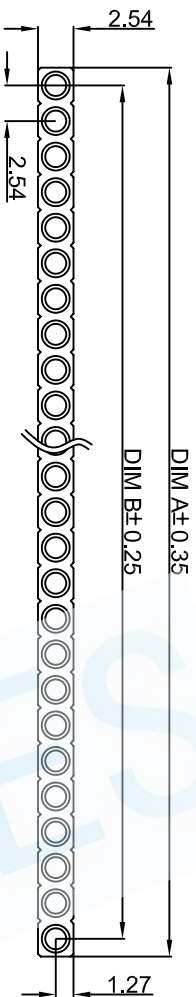


REV.	ECON NO.	DATE
1.0	RELEASED	01/04/04



P.C.B LAYOUT

CONTACT	DIM A	DIM B	CONTACT	DIM A	DIM B	CONTACT	DIM A	DIM A
01	2.54	—	15	38.10	35.56	29	73.66	71.12
02	5.08	2.54	16	40.64	38.10	30	76.20	73.66
03	7.62	5.08	17	43.18	40.64	31	78.74	76.20
04	10.16	7.62	18	45.72	43.18	32	81.28	78.74
05	12.7	10.16	19	48.26	45.72	33	83.82	81.28
06	15.24	12.7	20	50.80	48.26	34	86.36	83.82
07	17.78	15.24	21	53.34	50.80	35	88.90	86.36
08	20.32	17.78	22	55.88	53.34	36	91.44	88.90
09	22.86	20.32	23	58.42	55.88	37	93.98	91.44
10	25.40	22.86	24	60.96	58.42	38	96.52	93.98
11	27.94	25.40	25	63.50	60.96	39	99.06	96.52
12	30.48	27.94	26	66.04	63.50	40	101.16	99.06
13	33.02	30.48	27	68.58	66.04			
14	35.56	33.02	28	71.12	68.58			

TECHNICAL DATA:

MATERIAL:
 PIN (OUTER SLEEVE): BRASS MACHINED CUZn38PB2
 CLIP(CONTACT 4 FINGER): BERYLLIUM COPPER HEAT TREATED
 PLATING(OUTER SLEEVE): TIN PLATED: 2UM/80UM NICKEL. 5U" M/200U" TIN
 GOLD PLATED: 2UM/80UM NICKEL FULL GOLD
 INSULATOR BODY(HOUSING): PPS(UL94V-0)
 ELECTRICAL:
 CURRENT RATING: 3 AMPS/CONTACT MAX
 CONTACT RESISTANCE: <4MΩ/CONTACT
 INSULATION RESISTANCE: >1000MΩ AT V=100V
 OPERATING: 60 VAC/DC
 MECHANICAL:
 OPERATING TEMPERATURE: GOLD PLATED: -55°C TO +125°C
 (CONTINUOUS) TIN PLATED: -40°C TO +105°C
 AVERAGE INSERTION FORCE: <250g
 WITH STEEL PIN OF φ0.43MM/0.017
 AVERAGE WITHDRAWAL: >50g
 FORCE WITH STEEL PIN OF φ0.43MM/0.017
 MECHANICAL LIFE: MIN200
 SOLDERING TEMPERATURE: +260°C 10s MAX

ICS-XX-01-X

- POINT PLATED CODE
- 0 GOLD FLASH PIN PLATED TIN 200U"
 - 1 GOLD10U" TIN 200U"
 - 2 GOLD30U" TIN 200U"
 - 3 TIN200"U" TIN 200U"
 - 4 GOLDFLASH GOLD FLASH
 - 5 GOLD10U" GOLD FLASH
 - 6 GOLD30U" GOLD FLASH

NO.OF CONTACTS: 01-40

比例 (SCALE)	FREE	繪圖 (DRAW)	TANYI	
單位 (UNIT)	MM	審核 (CHECK)	/ /	
一般公差 (TOLERANCE)		承認 (AP" E)	/ /	圖名 (NAME) : SINGLE ROW STROP SOCKET PITCH 2.54MM

0.0 ± 0.35
 .00 ± 0.2
 ANG = ± 5°

投影法 PROJECTION	第三角		料號 (PART NO)	ICS-XX-01-X
			圖號 (DRAW NO)	20040401-23(WU)